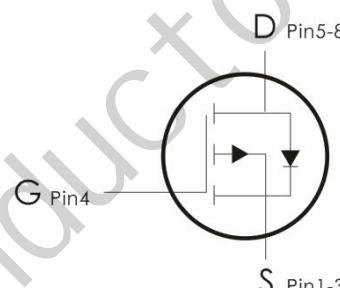
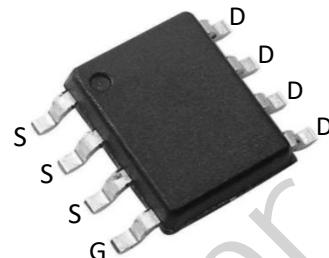


Description:

This P-Channel MOSFET uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge. It can be used in a wide variety of applications.



Features:

- 1) $V_{DS}=-60V, I_D=-8.5A, R_{DS(ON)}<30m\Omega @ V_{GS}=-10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low $R_{DS(ON)}$.
- 5) Excellent package for good heat dissipation.

Absolute Maximum Ratings: ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	-60	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current- $T_c=25^\circ C$	-8.5	A
	Continuous Drain Current- $T_c=100^\circ C$	-5.4	
I_{DM}	Drain Current-Pulsed ¹	-34	A
E_{AS}	Single Pulse Avalanche Energy ²	105	mJ
I_{AS}	Single Pulse Avalanche Current ²	-46	A
P_D	Power Dissipation	4.1	W
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ C$

Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{Theta A}$	Thermal Resistance,Junction to Ambient	62	$^\circ C / W$
$R_{Theta C}$	Thermal Resistance Junction to Case	30	$^\circ C / W$

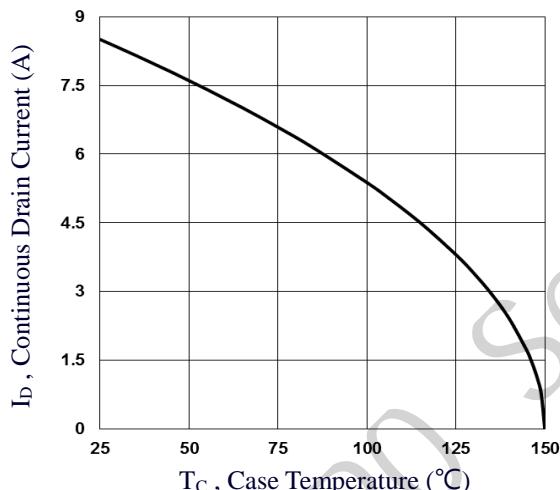
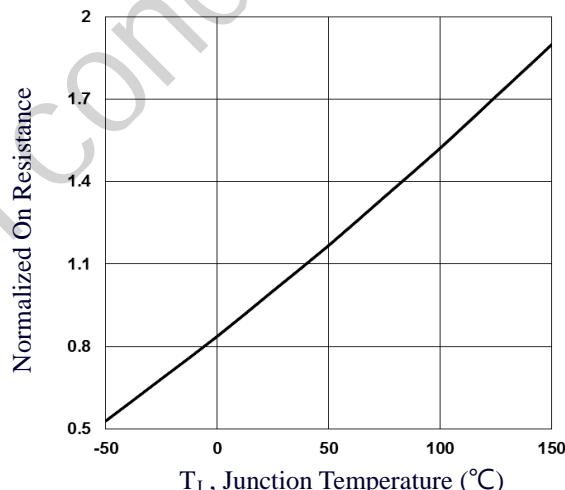
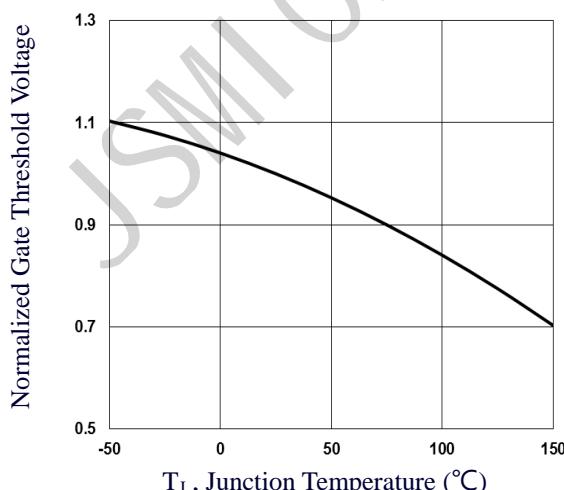
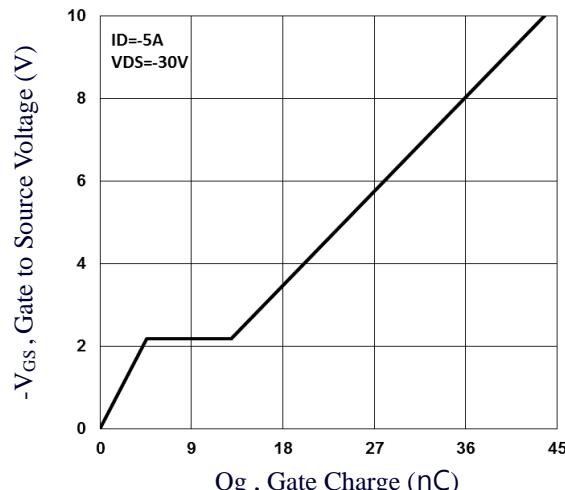
Electrical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

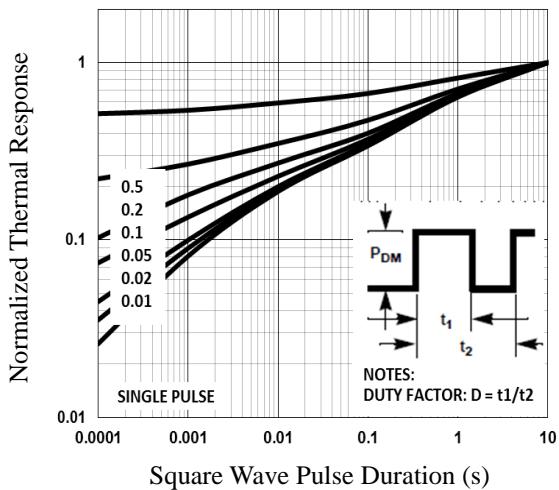
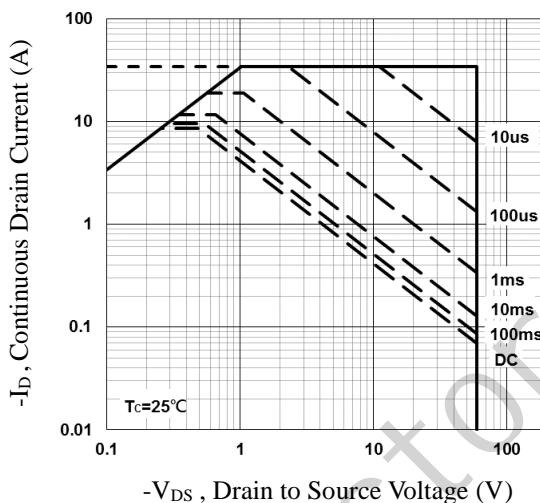
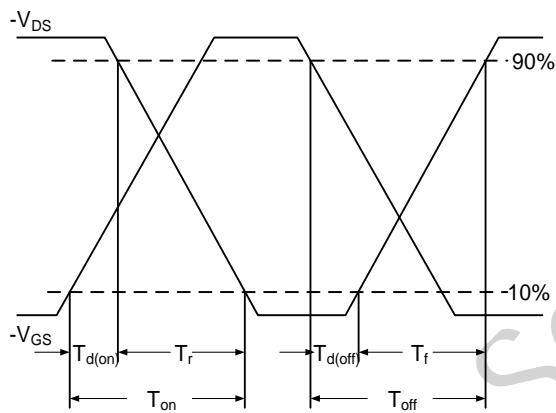
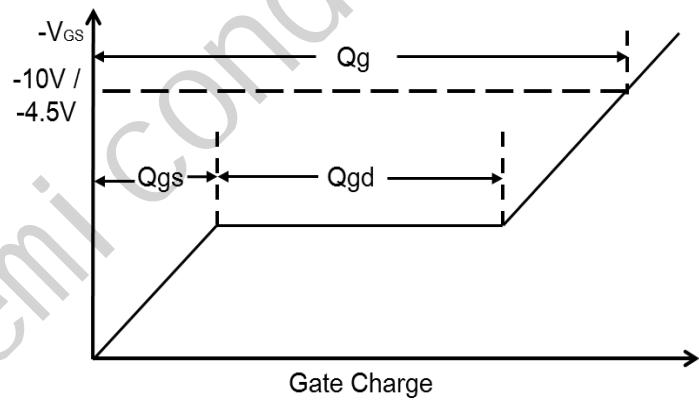
Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_D=250\ \mu\text{A}$	-60	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-60\text{V}, T_J=25^\circ\text{C}$	---	---	-1	μA
		$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-48\text{V}, T_J=125^\circ\text{C}$	---	---	-10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	± 100	nA
On Characteristics						
$V_{\text{GS}(\text{th})}$	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_D=250\ \mu\text{A}$	-1	-1.6	-2.5	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On Resistance	$V_{\text{GS}}=-10\text{V}, I_D=-8\text{A}$	---	23	30	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_D=-6\text{A}$	---	28	40	
G_{FS}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}, I_D=-3\text{A}$	---	18	---	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=-25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	2550	3850	pF
C_{oss}	Output Capacitance		---	160	230	
C_{rss}	Reverse Transfer Capacitance		---	110	165	
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-On Delay Time ^{3,4}	$V_{\text{DD}}=-30\text{V}, V_{\text{GS}}=-10\text{V}$ $I_D=-1\text{A}, R_{\text{GEN}}=6\ \Omega$	---	25	50	ns
t_r	Rise Time ^{3,4}		---	13.8	28	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time ^{3,4}		---	148	290	ns
t_f	Fall Time ^{3,4}		---	51	100	ns
Q_g	Total Gate Charge ^{3,4}		---	43.8	88	nC
Q_{gs}	Gate-Source Charge ^{3,4}	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=-10\text{V}, I_D=-5\text{A}$	---	4.6	9	nC
Q_{gd}	Gate-Drain "Miller" Charge ^{3,4}		---	8.3	17	nC
Drain-Source Diode Characteristics						

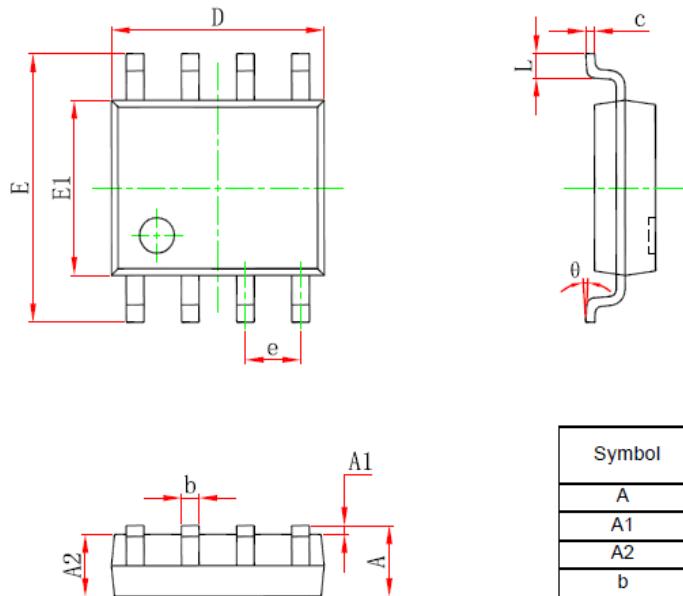
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	-8.5	A
I_{SM}	Pulsed Source Current		---	---	-17	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=-1A, T_J=25^\circ C$	---	---	-1	V
t_{rr}	Reverse Recovery Time	$V_R=-50V, I_S=-5A$	---	40	---	ns
Q_{rr}	Reverse Recovery Charge		$dI/dt=100A/\mu s, T_J=25^\circ C$	---	30	---
						nC

Notes:

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH, I_{AS}=-46A, R_g=25\Omega$, Starting $T_J=25^\circ C$.
- The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.

Typical Characteristics: ($T_c=25^\circ C$ unless otherwise noted)

Fig.1 Continuous Drain Current vs. T_c

Fig.2 Normalized RDS(on) vs. T_j

Fig.3 Normalized V_{th} vs. T_j

Fig.4 Gate Charge Waveform


Fig.5 Normalized Transient Impedance

Fig.6 Maximum Safe Operation Area

Fig.7 Switching Time Waveform

Fig.8 Gate Charge Waveform

SOP-8 Package information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.450	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
e	1.270 (BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°